## **Amendment and Response**

Applicant: Norman L. Oberski et al.

Serial No.: 10/6232,848 Filed: July 18, 2003 Docket No.: A126.113.102

Title: INSPECTION TOOL WITH A 3D POINT SENSOR TO DEVELOP A FOCUS MAP

## **IN THE ABSTRACT**

Please replace the paragraph beginning at page 9, line 4, with the following, re-written paragraph:

## **Abstract of the Disclosure**

An inspection system, and process for use thereof, allows for inspecting of semiconductors or like substrates. The inspection system keeps-includes an inspection device and an auxiliary sensor. The auxiliary sensor aids in the focus of focusing the sensor inspection device within the depth of field of the lens used. The system specifically uses the process of making a separate pass over the wafer surface using a 3D point sensor before the inspection of the wafer begins.